1	Method For Forming A MIM Capacitor
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3	Abstract
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5	A method of manufacturing a MIM capacitor which is characterized as
6	follows. We provide a semiconductor structure having a first region and a capacitor region.
7	Next we form a first conductive layer over the semiconductor structure. The first
8	conductive layer is patterned to form a plurality of trenches in the capacitor region. We
9	form a capacitor dielectric layer over the first conductive layer. We form a top plate over
10	the capacitor dielectric layer in the capacitor region. The first conductive layer in the first
11	region is patterned to form conductive patterns and a bottom plate. An interlevel dielectric
12	layer is formed over the first conductive layer and top plate.
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